

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Industrial networks – Profiles –
Part 1-3: Fieldbus profiles – Communication Profile Family 3**

**Réseaux industriels – Profils –
Partie 1-3: Profils de bus de terrain – Famille de profils de communication 3**





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CONTENTS

FOREWORD.....	6
INTRODUCTION.....	8
1 Scope.....	9
2 Normative references	9
3 Terms, definitions, abbreviated terms, symbols, and conventions	10
3.1 Terms and definitions.....	10
3.2 Abbreviations and symbols	10
3.2.1 Common abbreviations and symbols.....	10
3.2.2 Other abbreviations and symbols.....	10
3.3 Conventions.....	10
4 CPF 3 (PROFIBUS & PROFINET)	11
4.1 General overview.....	11
4.2 CP 3/1 (PROFIBUS DP).....	12
4.2.1 Physical layer	12
4.2.2 Data-link layer	14
4.2.3 Application layer.....	39
4.3 CP 3/2 (PROFIBUS PA).....	95
4.3.1 Physical layer	95
4.3.2 Data-link layer	99
4.3.3 Application layer.....	111
Annex A (informative) CPF 3 (PROFIBUS & PROFINET) communication concepts	112
A.1 Basic characteristics	112
A.1.1 General	112
A.1.2 PROFIBUS DP	112
A.2 Physical layer profiles	113
A.3 Communication feature list (GSD).....	113
Bibliography.....	115
Figure 1 – CP 3/2 Slave devices usable in applications.....	12
Table 1 – CPF 3: overview of profile sets.....	11
Table 2 – CP 3/1: PhL selection.....	12
Table 3 – CP 3/1: PhL selection of Clause 3	14
Table 4 – CP 3/1: PhL selection of Clause 4	14
Table 5 – CP 3/1: General DLL service selection	15
Table 6 – CP 3/1: DLL service selection for DP-V0 master (class 1)	16
Table 7 – CP 3/1: DLM service selection for DP-V0 master (class 1).....	17
Table 8 – CP 3/1: DLL service selection for DP-V1 master (class 1)	18
Table 9 – CP 3/1: DLM service selection for DP-V1 master (class 1).....	19
Table 10 – CP 3/1: DLL service selection for DP-V0 master (class 2).....	19
Table 11 – CP 3/1: DLL service selection for DP-V1 master (class 2).....	20
Table 12 – CP 3/1: DLL service selection for DP-V0 slave	22
Table 13 – CP 3/1: DLM service selection for DP-V0 slave	23
Table 14 – CP 3/1: DLL service selection for DP-V1 slave	24

Table 15 – CP 3/1: DLM service selection for DP-V1 slave	25
Table 16 – CP 3/1: General DLL protocol selection	26
Table 17 – CP 3/1: DLL protocol selection of Clause 5.....	26
Table 18 – CP 3/1: DLL protocol selection of Clause 6.....	27
Table 19 – CP 3/1: DLL protocol selection of Clause 7.....	27
Table 20 – CP 3/1: Time variable selection for DP-V0 master (class 1).....	28
Table 21 – CP 3/1: Timer and counter selection for DP-V0 master (class 1).....	29
Table 22 – CP 3/1: DLPDU selection for DP-V0 master (class 1)	29
Table 23 – CP 3/1: MAC state selection for DP-V0 master (class 1).....	30
Table 24 – CP 3/1: Time selection for DP-V1 master (class 1)	31
Table 25 – CP 3/1: Timer and counter selection for DP-V1 master (class 1).....	32
Table 26 – CP 3/1: DLPDU selection for DP-V1 master (class 1)	32
Table 27 – CP 3/1: MAC state selection for DP-V1 master (class 1).....	33
Table 28 – CP 3/1: CS protocol selection for DP-V1 master (class 1).....	33
Table 29 – CP 3/1: Time selection for DP-V1 master (class 2)	34
Table 30 – CP 3/1: Timer and counter selection for DP-V1 master (class 2).....	34
Table 31 – CP 3/1: DLPDU selection for DP-V1 master (class 2)	35
Table 32 – CP 3/1: Time selection for DP-V0 slave	35
Table 33 – CP 3/1: Timer and counter selection for DP-V0 slave	36
Table 34 – CP 3/1: DLPDU selection for DP-V0 slave	36
Table 35 – CP 3/1: MAC state selection for DP-V0 slave	37
Table 36 – CP 3/1: Time selection for DP-V1 slave	37
Table 37 – CP 3/1: Timer and counter selection for DP-V1 slave	38
Table 38 – CP 3/1: DLPDU selection for DP-V1 slave	38
Table 39 – CP 3/1: CS protocol selection for DP-V1 slave	39
Table 40 – CP 3/1, 3/2: AL service selection.....	39
Table 41 – CP 3/1, 3/2: AL service selection of Clause 6	40
Table 42 – CP 3/1, 3/2: AL service selection of I/O data ASE.....	40
Table 43 – CP 3/1, 3/2: AL service selection of Diagnosis ASE.....	41
Table 44 – CP 3/1, 3/2: AL service selection of Context ASE	41
Table 45 – CP 3/1, 3/2: AL service selection of Management ASE	42
Table 46 – CP 3/1, 3/2: AL service selection of AR ASE	43
Table 47 – CP 3/1, 3/2: AL service selection of Clause 6	44
Table 48 – CP 3/1, 3/2: AL service selection of Process data ASE.....	44
Table 49 – CP 3/1, 3/2: AL service selection of I/O data ASE.....	45
Table 50 – CP 3/1, 3/2: AL service selection of Alarm ASE	45
Table 51 – CP 3/1, 3/2: AL service selection of Context ASE	45
Table 52 – CP 3/1, 3/2: AL service selection of Load region ASE.....	46
Table 53 – CP 3/1, 3/2: AL service selection of Function invocation ASE.....	46
Table 54 – CP 3/1, 3/2: AL service selection of Time ASE	46
Table 55 – CP 3/1, 3/2: AL service selection of AR ASE	47
Table 56 – CP 3/1, 3/2: AL service selection of Clause 6	48
Table 57 – CP 3/1, 3/2: AL service selection of I/O data ASE.....	48

Table 58 – CP 3/1, 3/2: AL service selection of Diagnosis ASE	49
Table 59 – CP 3/1, 3/2: AL service selection of Context ASE	49
Table 60 – CP 3/1, 3/2: AL service selection of Management ASE	49
Table 61 – CP 3/1, 3/2: AL service selection of AR ASE	50
Table 62 – CP 3/1, 3/2: AL service selection of Clause 6	51
Table 63 – CP 3/1, 3/2: AL service selection of Process data ASE	51
Table 64 – CP 3/1, 3/2: AL service selection of Context ASE	52
Table 65 – CP 3/1, 3/2: AL service selection of Load region ASE	52
Table 66 – CP 3/1, 3/2: AL service selection of Function invocation ASE	53
Table 67 – CP 3/1, 3/2: AL service selection of Time ASE	53
Table 68 – CP 3/1, 3/2: AL service selection of AR ASE	54
Table 69 – CP 3/1, 3/2: AL service selection of Clause 6	55
Table 70 – CP 3/1, 3/2: AL service selection of I/O data ASE	56
Table 71 – CP 3/1, 3/2: AL service selection of Diagnosis ASE	57
Table 72 – CP 3/1, 3/2: AL service selection of Context ASE	58
Table 73 – CP 3/1, 3/2: AL service selection of AR ASE	59
Table 74 – CP 3/1, 3/2: AL service selection of Clause 6	60
Table 75 – CP 3/1, 3/2: AL service selection of Process data ASE	60
Table 76 – CP 3/1, 3/2: AL service selection of I/O data ASE	61
Table 77 – CP 3/1, 3/2: AL service selection of diagnosis ASE	61
Table 78 – CP 3/1, 3/2: AL service selection of Alarm ASE	62
Table 79 – CP 3/1, 3/2: AL service selection of Context ASE	62
Table 80 – CP 3/1, 3/2: AL service selection of Load region ASE	63
Table 81 – CP 3/1, 3/2: AL service selection of Function invocation ASE	63
Table 82 – CP 3/1, 3/2: AL service selection of Time ASE	63
Table 83 – CP 3/1, 3/2: AL service selection of AR ASE	64
Table 84 – CP 3/1, 3/2: AL protocol selection	65
Table 85 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11	65
Table 86 – CP 3/1, 3/2: AL protocol selection of APDUs	67
Table 87 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives	68
Table 88 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives	69
Table 89 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11	69
Table 90 – CP 3/1, 3/2: AL protocol selection of APDUs	71
Table 91 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives	72
Table 92 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives	74
Table 93 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 6	74
Table 94 – CP 3/1, 3/2: AL protocol selection of APDUs	76
Table 95 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives	77
Table 96 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives	77
Table 97 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11	78
Table 98 – CP 3/1, 3/2: AL protocol selection of APDUs	80
Table 99 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives	82
Table 100 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives	83

Table 101 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11	83
Table 102 – CP 3/1, 3/2: AL protocol selection of APDU selection	85
Table 103 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives.....	86
Table 104 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	87
Table 105 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11	87
Table 106 – CP 3/1, 3/2: AL protocol selection of APDUs	89
Table 107 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives.....	91
Table 108 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	93
Table 109 – CP 3/2: PhL selection	95
Table 110 – CP 3/2: PhL selection of Clause 12 for devices and their MAUs.....	97
Table 111 – CP 3/2: PhL selection of recommended IS parameters	98
Table 112 – CP 3/2: PhL selection of Clause 21 for devices and their MAUs.....	98
Table 113 – CP 3/2: General DLL protocol selection	100
Table 114 – CP 3/2: DLL protocol selection of Clause 4.....	100
Table 115 – CP 3/2: DLL protocol selection of Clause 5.....	101
Table 116 – CP 3/2: DLL protocol selection of Clause 6.....	101
Table 117 – CP 3/2: DLL protocol selection of Clause 7	102
Table 118 – CP 3/2: Time variable selection for DP-V0 master (class 1).....	103
Table 119 – CP 3/2: Timer and counter selection for DP-V0 master (class 1).....	103
Table 120 – CP 3/2: DLPDU selection for DP-V0 master (class 1)	104
Table 121 – CP 3/2: Time variable selection for DP-V1 master (class 1).....	105
Table 122 – CP 3/2: Timer and counter selection for DP-V1 master (class 1).....	106
Table 123 – CP 3/2: DLPDU selection for DP-V1 master (class 1)	106
Table 124 – CP 3/2: Time variable selection for DP-V1 master (class 2).....	107
Table 125 – CP 3/2: Timer and counter selection for DP-V1 master (class 2).....	108
Table 126 – CP 3/2: DLPDU selection for DP-V1 master (class 2)	108
Table 127 – CP 3/2: Time variable selection for DP-V0 slave	109
Table 128 – CP 3/2: Timer and counter selection for DP-V0 slave	109
Table 129 – CP 3/2: DLPDU selection for DP-V0 slave	110
Table 130 – CP 3/2: Time variable selection for DP-V1 slave.....	110
Table 131 – CP 3/2: Timer and counter selection for DP-V1 slave	111
Table 132 – CP 3/2: DLPDU selection for DP-V1 slave	111

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INDUSTRIAL NETWORKS – PROFILES –

Part 1-3: Fieldbus profiles – Communication Profile Family 3

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IEC 61784-1-3 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This first edition, together with the other parts of the same series, cancels and replaces the fifth edition of IEC 61784-1 published in 2019. This first edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC 61784-1:2019:

- a) split of the original IEC 61784-1 into several subparts, one subpart for the material of a generic nature, and one subpart for each Communication Profile Family specified in the original document.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65C/1207/FDIS	65C/1236/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

A list of all parts of the IEC 61784-1 series, published under the general title *Industrial networks – Profiles – Part 1: Fieldbus profiles*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
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INTRODUCTION

The IEC 61784-1 series provides a set of Communication Profiles (CP) in the sense of ISO/IEC TR 10000-1. These answer the need of identifying the protocol families co-existing within the IEC 61158 series, as a result of the international harmonization of fieldbus technologies available on the market. More specifically, these profiles help to correctly state the compliance with the IEC 61158 series, and to avoid the spreading of divergent implementations, which would limit its use, clearness and understanding. Additional profiles to address specific market concerns, such as functional safety or information security, can be addressed by future parts of the IEC 61784-1 series.

The IEC 61784-1 series contains several Communication Profile Families (CPF), which specify one or more communication profiles. Such profiles identify, in a strict sense, protocol subsets of the IEC 61158 series via protocol specific communication profiles. They do not define device profiles that specify communication profiles together with application functions needed to answer the need of a specific application ("application profiles").

It is agreed that these latter classes of profiles would facilitate the use of the IEC 61158 series of standards; the profiles defined in the IEC 61784-1 series are a necessary step to achieve that task.

It is also important to clarify that interoperability – defined as the ability of two or more network systems to exchange information and to make mutual use of the information that has been exchanged (see ISO/IEC TR 10000-1) – can be directly achieved on the same link only for those devices complying with the same communication profile.

Profiles contained in the IEC 61784-1 series are constructed of references to IEC 61158-2 and the IEC 61158-3, IEC 61158-4, IEC 61158-5 and IEC 61158-6 series, and other IS, TS or worldwide-accepted standards, as appropriate¹. Each profile is required to reference at least one part of the IEC 61158 series in addition to IEC 61158-1.

Two or more Profiles, which are related to a common family, are specified within a "Communication Profile Family" (CPF).

¹ International Standardised Profiles may contain normative references to specifications other than International Standards; see ISO/IEC JTC 1 N 4047: *The Normative Referencing of Specifications other than International Standards in JTC 1 International Standardized Profiles – Guidelines for ISP Submitters*.